

40V +175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
40V	$4.5 \text{m}\Omega$ @ V _{GS} = 10V	105A

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching, Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH43M8SPDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

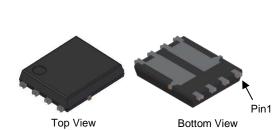
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

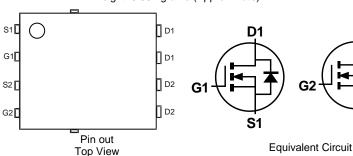
PowerDI5060-8/SWP (Type UXD)

- Backlighting
- Power Management Functions
- DC-DC Converters

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)





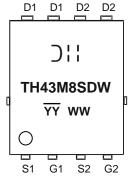
Ordering Information (Note 4)

Part Number	Backago	Packing		
Part Number	Package	Qty.	Carrier	
DMTH43M8SPDWQ-13	PowerDI5060-8/SWP (Type UXD)	2,500pcs	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Dili = Manufacturer's Marking
TH43M8SDW = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 21 = 2021)
WW = Week (01 to 53)

D2



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	40	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$		I _D	105 74	А
Maximum Continuous Body Diode Forward Current (Note 6)		Is	105	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	420	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	I _{SM}	420	A	
Avalanche Current, L = 0.1mH	I _{AS}	44	А	
Avalanche Energy, L = 0.1mH	Eas	97	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	3	W
Thermal Resistance, Junction to Ambient (Note 5) Steady State		Reja	50	°C/W
Total Power Dissipation (Note 6)	PD	76	W	
Thermal Resistance, Junction to Case (Note 6)	Rejc	2	°C/W	
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +175	°C	

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

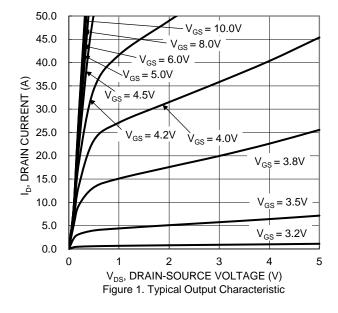
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40	_	_	V	$V_{GS} = 0V$, $I_{D} = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2		4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)		3.3	4.5	mΩ	VGS = 10V, ID = 20A	
Diode Forward Voltage	VsD	_	0.81	1.2	V	Vgs = 0V, Is = 15A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	l	2958	_	pF	\/ 20\/ \/ 0\/	
Output Capacitance	Coss	_	805	_	pF	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	85	_	pF		
Gate Resistance	R_g	_	2.4	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge, V _{GS} = 4.5V	Qg	_	17	_	nC		
Total Gate Charge, V _{GS} = 10V	Qg	_	40	_	nC	V _{DS} = 20V, I _D = 20A	
Gate-Source Charge	Qgs	_	10.8	_	nC	VDS - 20V, ID - 20A	
Gate-Drain Charge	Q _{gd}	_	2.6	_	nC	1	
Turn-On Delay Time	td(on)	_	5.1	_	ns		
Turn-On Rise Time	t _R	_	5.1	_	ns	V_{DD} = 20V, V_{GS} = 10V, I_{D} = 20A, R_{g} = 3 Ω	
Turn-Off Delay Time	tD(OFF)	_	32	_	ns		
Turn-Off Fall Time	t _F	_	10.8	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	_	79	_	ns	L = 200 di/dt = 1000///c	
Body Diode Reverse Recovery Charge	Qrr		77	_	nC	-I _F = 20A, di/dt = 100A/μs	

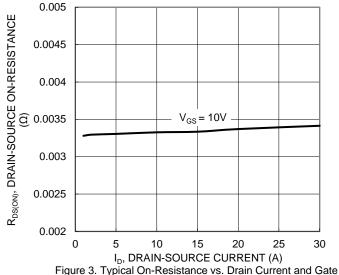
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

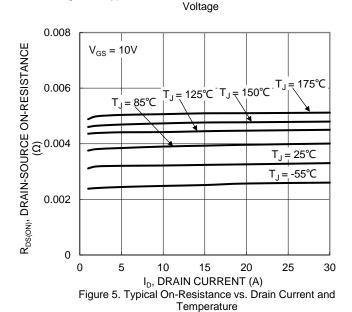
6. Thermal resistance from junction to soldering point (on the exposed drain pad). 7. Short duration pulse test used to minimize self-heating effect.

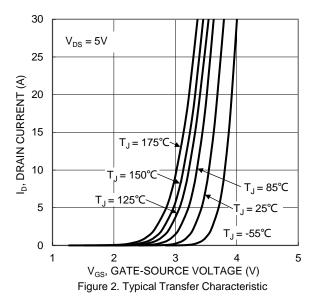
8. Guaranteed by design. Not subject to product testing.

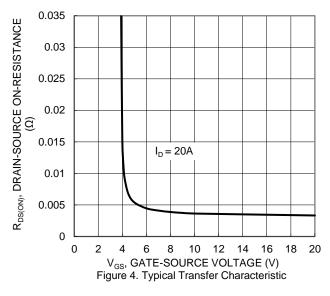












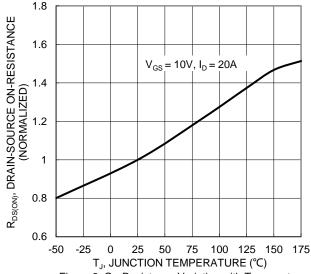


Figure 6. On-Resistance Variation with Temperature



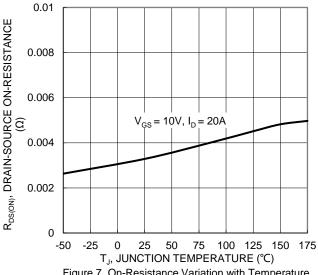
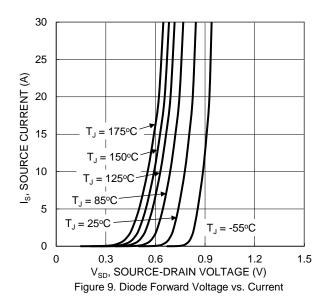


Figure 7. On-Resistance Variation with Temperature



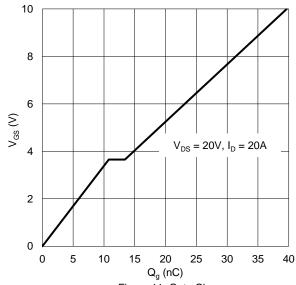


Figure 11. Gate Charge

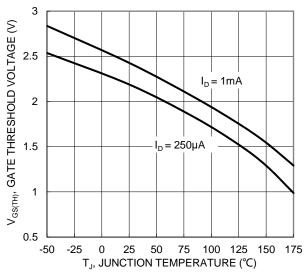
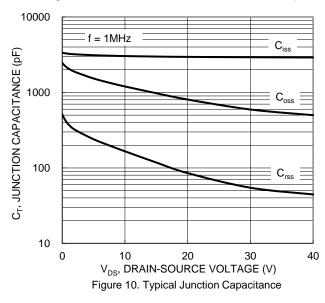
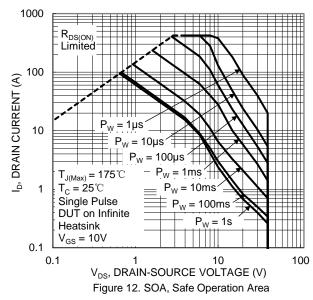


Figure 8. Gate Threshold Variation vs. Junction Temperature







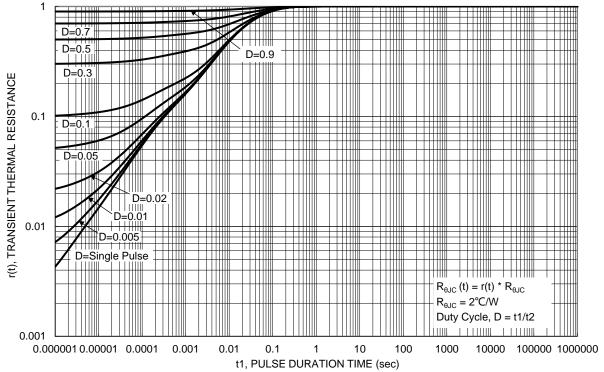


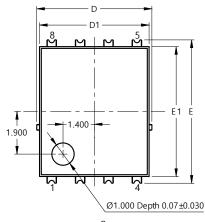
Figure 13. Transient Thermal Resistance

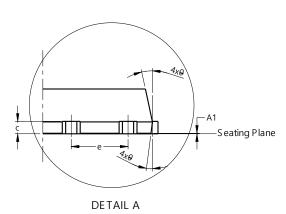


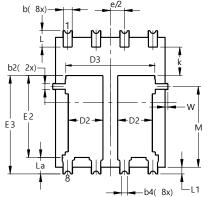
Package Outline Dimensions

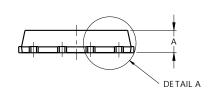
Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)







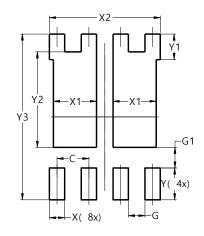


PowerDI5060-8/SWP					
(Type UXD)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF	-		
С	0.230	0.330	0.277		
D	5	.15 BS0	2		
D1	4.70	5.10	4.90		
D2	1.46	1.66	1.55		
D3	3.78	4.18	3.98		
Е	6	.40 BS0	\sim		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BS0)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
М	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	1.720		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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